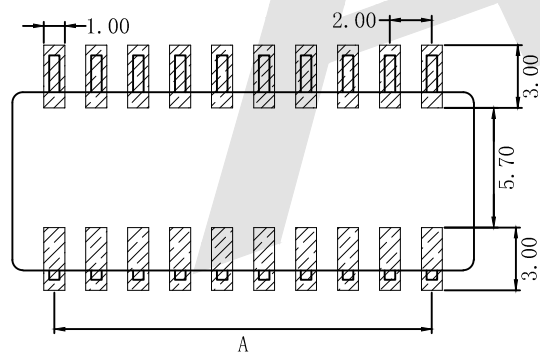
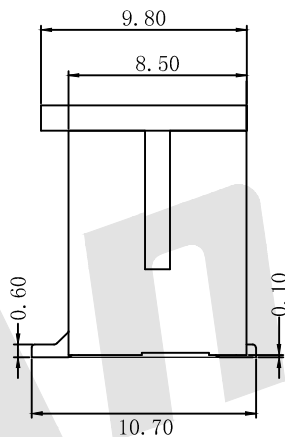
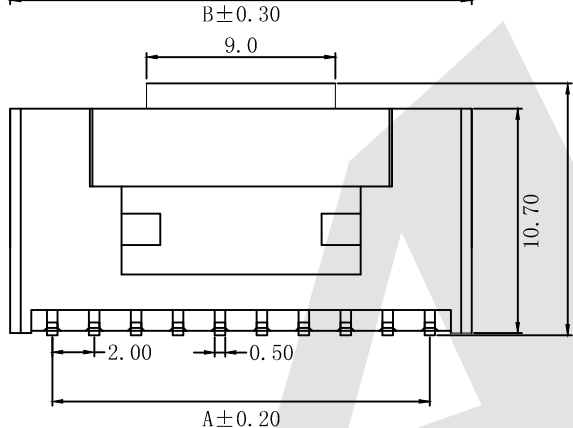
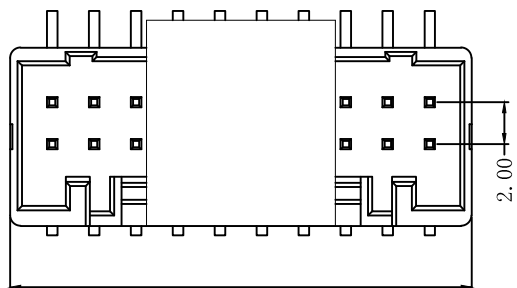


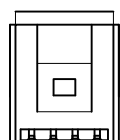
HSF



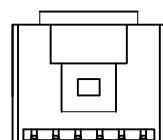
ROHS



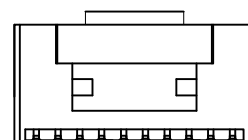
Recommended P.C.B Layout



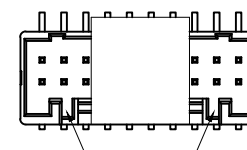
8-10Pin



12-18Pin



20-40Pin



8P~10P Without Guideway
12P~40P With Guideway
Scale:1/0.4

Poles	Dimension(mm)	
	A	B
2x04	6.00	10.00
2x05	8.00	12.00
2x06	10.00	14.00
2x07	12.00	16.00
2x08	14.00	18.00
2x09	16.00	20.00
2x10	18.00	22.00
2x11	20.00	24.00
2x12	22.00	26.00
2x13	24.00	28.00
2x14	26.00	30.00
2x15	28.00	32.00
2x16	30.00	34.00
2x17	32.00	36.00
2x18	34.00	38.00
2x19	36.00	40.00
2x20	38.00	42.00

Specifications :

Voltage rating: 250V AC / DC
Current rating: 3A AC / DC
Withstanding voltage: 800V AC/minute
Temperature range: -25°C~+85°C
Insulation resistance: ≥1000MΩ
Contact resistance: ≤10mΩ
After environmental testing: ≤20mΩ

Wafer:

Part No.:AW2016M-2xNP

Material:

Housing:LCP,UL94V-0

Contact:Brass

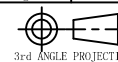
Finish:Matte Tin

Mate With:AH2016

Q'ty/Reel:200Pcs

Unless Otherwise specified tolerance
X. ±0.35 X.XX: ±0.20
X.X: ±0.25 X.XXX: ±0.15

SCALE: As Shown UNIT: mm
DRAW ZLA DATE 11/05/2022
CHECK BobYang DATE 11/05/2022



ANTENK ELECTRONICS CO., LTD
Http://www.antenk.com
E-mail:sales@antenk.com

TITLE:
2.00mm Pitch SMT Wafer Connector Series

DRAWING NO: AW2016M-2xNP

PRODUCT NO: AW2016M-2xNP

REV DESCRIPTION

DATE

1 2 3 4 5 6 7 8